

# 101419C

RD150-35-8W- 150 MHz Dispersive Delay Line 35 MHz Bandwidth

## Specifications

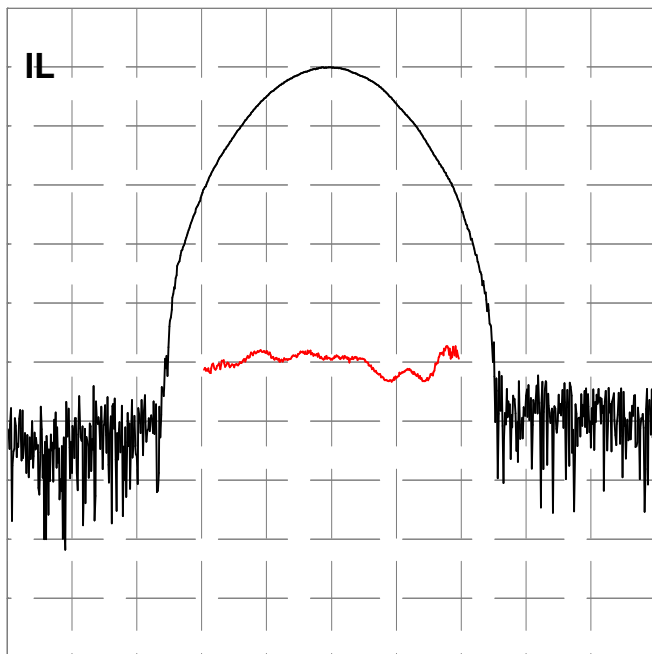
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	$F_0$		150		MHz
Bandwidth	B		35		MHz
Dispersion	T		8		$\mu\text{sec}$
Delay	$T_0$	7.6	7.613	7.64	$\mu\text{sec}$
Insertion Loss	IL		27.6	28.5	dB
Slope	$S_0$	-0.229	-0.229	-0.228	$\mu\text{s}/\text{MHz}$
Pulse Width at -3 dB			0.0384	0.0385	$\mu\text{sec}$
Sidelobes for $ t - T_0  < T$			-41.2	-34	dB
Time Spurious for $ t - T_0  > T$			-63	-60	dB
Substrate Material		YZ-LN			

### Notes

- Center Frequency ( $F_0$ ) and Bandwidth (B) are defined, not measured. Dispersion (T) is defined as  $|B * S_0|$ .
- Insertion Loss is the minimum loss for  $|f - F_0| < .5B$
- Delay and Slope determined by best fit quadratic pulse in  $|f - F_0| < .5B$ .
- Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts  $dF_0 = -x * F_0$ ,  $dT_0 = x * (T_0 + S_0 * F_0)$ ,  $dS_0 = x * 2 * S_0$ , where  $x = 94E-6 * (\text{temperature} - 22 \text{ °C})$

## Typical Performance

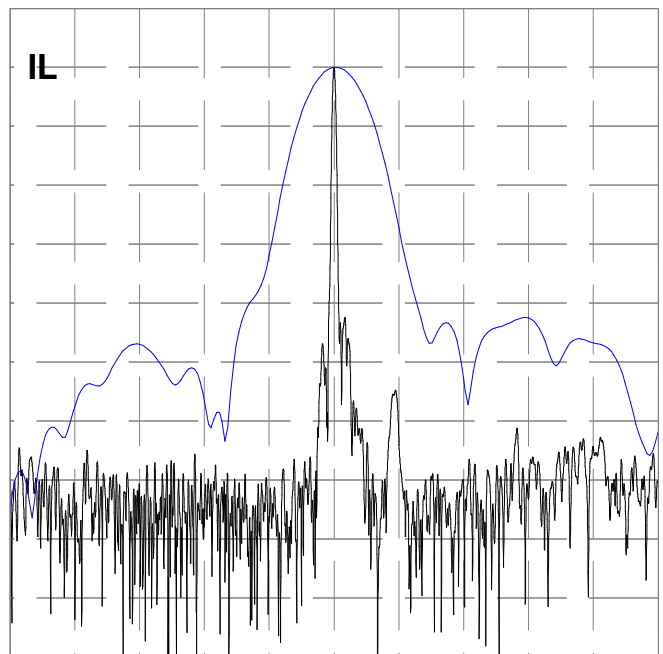
**Frequency Response**  
(Best Fit Quadratic Phase Removed)



10 dB/div, 10 deg/div, 8.000 MHz/div

**Compressed Pulse Response**

FFT(Frequency Response \* Cos(0.5 \* PI \* MIN(1, MAX(0, |f - F0| \* 2.0 / B - 1.0)))^2)

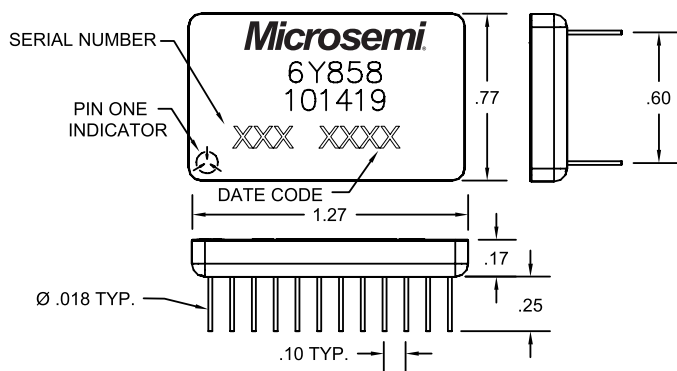


10 dB/div, 1.000 us/div, 0.057 us/div

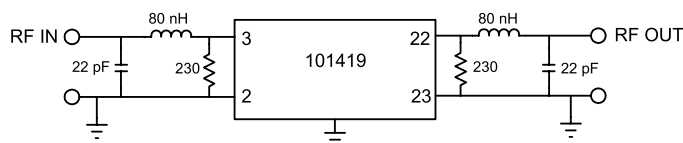
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## Package Outline



## Matching



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